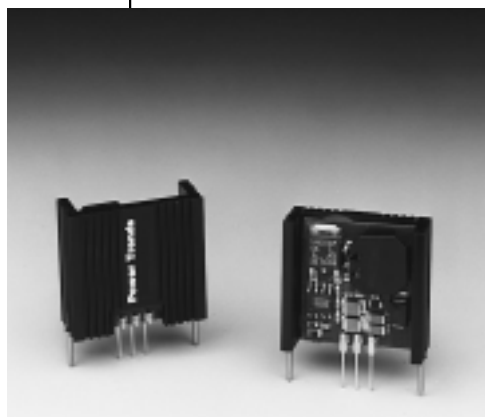
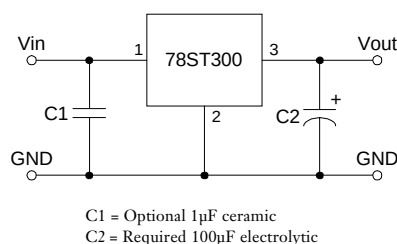


78ST300 Series**3 AMP POSITIVE STEP-DOWN
INTEGRATED SWITCHING REGULATOR****Revised 6/30/98**

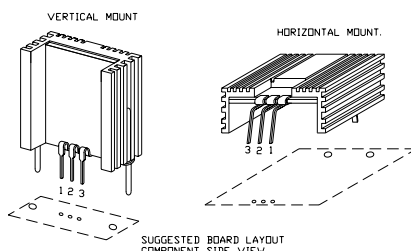
- High Efficiency > 80%
- Wide Input Range
- Self-Contained Inductor
- Short-Circuit Protection
- Over-Temperature Protection
- Fast Transient Response

The 78ST300 is a series of wide input voltage, 3 terminal Integrated Switching Regulators (ISRs). Employing a ceramic substrate, these ISRs have a maximum output current of 3A. The output voltage is laser trimmed for high accuracy.

The 78ST300 series regulators have internal short-circuit and over-temperature protection and may be used in a wide variety of applications.

Standard Application**Pin-Out Information**

Pin No.	Function
1	V _{in}
2	GND
3	V _{out}

**Ordering Information****78ST3 XX Y C**

Output Voltage

05 = 5.0 Volts

Package Suffix

V = Vertical Mount
H = Horizontal Mount

(For dimensions and PC board layout see Package Style 600.)

Specifications

Characteristics (T _a = 25°C unless noted)	Symbols	Conditions	78ST300 SERIES			
			Min	Typ	Max	Units
Output Current	I _o	Over V _{in} range	0.1*	—	3.0	A
Input Voltage Range	V _{in}	I _o = 0.1 to 3.0A	8	—	20	V
Output Voltage Tolerance	ΔV _o	Over V _{in} range T _a = 0°C to +60°C	—	±1.0	±2.0	%V _o
Line Regulation	Reg _{line}	Over V _{in} range	—	±0.4	±0.8	%V _o
Load Regulation	Reg _{load}	0.1 ≤ I _o ≤ 3.0A	—	±0.2	±0.4	%V _o
Ripple/Noise	V _n	V _{in} = V _{in} min, I _o = 3.0A	—	1	—	%V _o
Transient Response (with 100 μ F output cap)	t _{tr}	50% load change V _o over/undershoot	—	100 5.0	—	μ Sec %V _o
Efficiency	η	V _{in} = 9V, I _o = 3.0A	—	80	—	%
Switching Frequency	f _o	Over V _{in} and I _o ranges	0.95	1.0	1.05	MHz
Absolute Maximum Operating Temperature Range	T _a	—	-40	—	+70	°C
Recommended Operating Temperature Range	T _a	Free Air Convection, (40-60LFM) Over V _{in} and I _o ranges	-40	—	+70**	°C
Thermal Resistance	θ _{ja}	Free Air Convection, (40-60LFM)	—	35	—	°C/W
Storage Temperature	T _s	—	-40	—	+125	°C
Mechanical Shock	—	Per Mil-STD-883D, Method 2002.3	—	500	—	G's
Mechanical Vibration	—	Per Mil-STD-883D, Method 2007.2, 20-2000 Hz, soldered in a PC board	—	10	—	G's
Weight	—	—	—	11	—	Grams

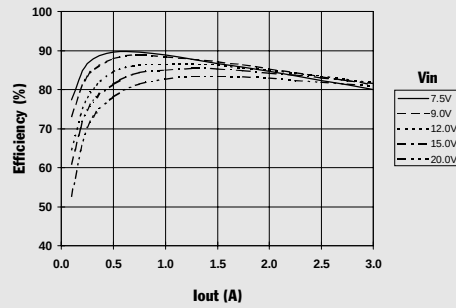
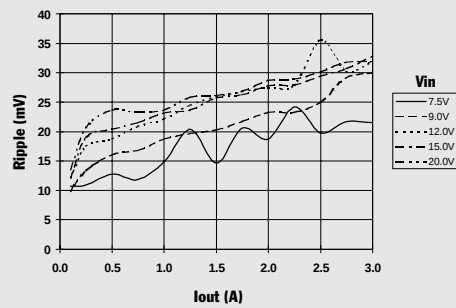
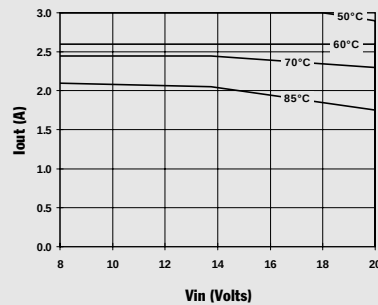
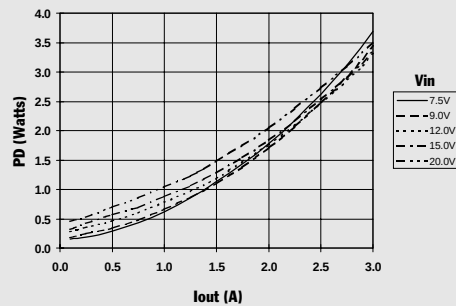
* ISR will operate down to no load with reduced specifications.

** See Thermal Derating chart.

Note: The 78ST300 Series requires a 100 μ F electrolytic or tantalum output capacitor for proper operation in all applications.

CHARACTERISTIC DATA**78ST300 Series****78ST305 5.0 VDC**

(See Note 1)

Efficiency vs Output Current**Ripple vs Output Current****Thermal Derating (T_a)** (See Note 2)**Power Dissipation vs Output Current****Note 1:** All data listed in the above graphs, except for derating data, has been developed from actual products tested at 25°C. This data is considered typical data for the ISR.**Note 2:** Thermal derating graphs are developed in free air convection cooling of 40-60 LFM. (See Thermal Application Note)

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